

Basic information	
2013/2905(DEA) DEA - Delegated acts procedure Exemption for lead in solders on printed circuit boards, termination coatings of electrical and electronic components and coatings of printed circuit boards, solders for connecting wires and cables, solders connecting transducers and sensors that are used durably at a temperature below -20°C Supplementing 2008/0240(COD) Subject 3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)	Procedure completed - delegated act enters into force

Key players			
European Parliament	Committee responsible	Rapporteur	Appointed
	<div style="border: 1px solid red; display: inline-block; padding: 2px;">ENVI</div> Environment, Public Health and Food Safety		

Key events			
Date	Event	Reference	Summary
18/10/2013	Non-legislative basic document published	C(2013)06798	
18/10/2013	Initial period for examining delegated act 2 month(s)		
23/10/2013	Committee referral announced in Parliament		
19/12/2013	Delegated act not objected by Council		
07/01/2014	Delegated act not objected by Parliament		

Technical information	
Procedure reference	2013/2905(DEA)
Procedure type	DEA - Delegated acts procedure
Procedure subtype	Examination of delegated act
	Supplementing 2008/0240(COD)
Stage reached in procedure	Procedure completed - delegated act enters into force
Committee dossier	ENVI/7/14364

Documentation gateway			
European Commission			
Document type	Reference	Date	Summary

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